# 74LVC1G74

Single D-type flip-flop with set and reset; positive edge trigger

Rev. 12 — 2 April 2013 Product data sheet

### 1. General description

The 74LVC1G74 is a single positive edge triggered D-type flip-flop with individual data  $\overline{Q}$  inputs, clock (CP) inputs, set  $\overline{Q}$  and reset  $\overline{Q}$  inputs, and complementary  $\overline{Q}$  and  $\overline{Q}$  outputs.

This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing damaging backflow current through the device when it is powered down.

The set and reset are asynchronous active LOW inputs and operate independently of the clock input. Information on the data input is transferred to the Q output on the LOW-to-HIGH transition of the clock pulse. The D inputs must be stable one set-up time prior to the LOW-to-HIGH clock transition for predictable operation.

Schmitt trigger action at all inputs makes the circuit highly tolerant of slower input rise and fall times.

#### 2. Features and benefits

- Wide supply voltage range from 1.65 V to 5.5 V
- 5 V tolerant inputs for interfacing with 5 V logic
- High noise immunity
- Complies with JEDEC standard:
  - ◆ JESD8-7 (1.65 V to 1.95 V)
  - ◆ JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - ◆ HBM JESD22-A114F exceeds 2000 V
  - ♦ MM JESD22-A115-A exceeds 200 V
- $\pm$  24 mA output drive (V<sub>CC</sub> = 3.0 V)
- CMOS low power consumption
- Latch-up performance exceeds 250 mA
- Direct interface with TTL levels
- Inputs accept voltages up to 5 V
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



#### Single D-type flip-flop with set and reset; positive edge trigger

# 3. Ordering information

Table 1. Ordering information

Type number	Package								
	Temperature range	Name	Description	Version					
74LVC1G74DP	−40 °C to +125 °C	TSSOP8	plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm	SOT505-2					
74LVC1G74DC	–40 °C to +125 °C	VSSOP8	plastic very thin shrink small outline package; 8 leads; body width 2.3 mm	SOT765-1					
74LVC1G74GT	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 1 $\times$ 1.95 $\times$ 0.5 mm	SOT833-1					
74LVC1G74GF	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1 $\times$ 0.5 mm	SOT1089					
74LVC1G74GD	–40 °C to +125 °C	XSON8	plastic extremely thin small outline package; no leads; 8 terminals; body 3 $\times$ 2 $\times$ 0.5 mm	SOT996-2					
74LVC1G74GM	–40 °C to +125 °C	XQFN8	plastic, extremely thin quad flat package; no leads; 8 terminals; body 1.6 $\times$ 1.6 $\times$ 0.5 mm	SOT902-2					
74LVC1G74GN	–40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body $1.2 \times 1.0 \times 0.35$ mm	SOT1116					
74LVC1G74GS	-40 °C to +125 °C	XSON8	extremely thin small outline package; no leads; 8 terminals; body 1.35 $\times$ 1.0 $\times$ 0.35 mm	SOT1203					

## 4. Marking

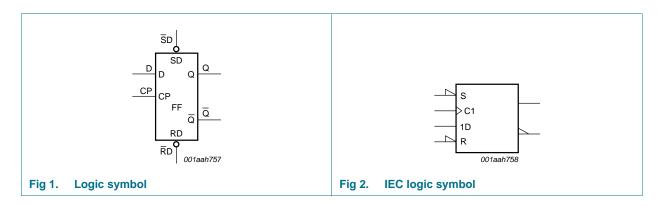
Table 2. Marking codes

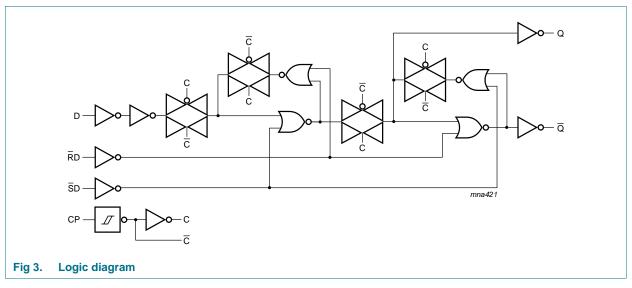
Type number	Marking code <sup>[1]</sup>
74LVC1G74DP	V74
74LVC1G74DC	V74
74LVC1G74GT	V74
74LVC1G74GF	Y4
74LVC1G74GD	V74
74LVC1G74GM	V74
74LVC1G74GN	Y4
74LVC1G74GS	Y4

<sup>[1]</sup> The pin 1 indicator is located on the lower left corner of the device, below the marking code.

#### Single D-type flip-flop with set and reset; positive edge trigger

# 5. Functional diagram

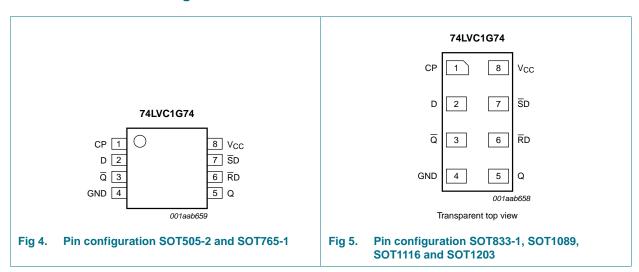


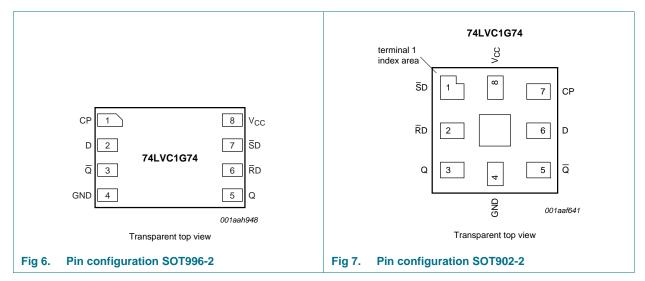


#### Single D-type flip-flop with set and reset; positive edge trigger

# 6. Pinning information

### 6.1 Pinning





#### Single D-type flip-flop with set and reset; positive edge trigger

### 6.2 Pin description

Table 3. Pin description

Symbol	Pin	Description	
	SOT505-2, SOT765-1, SOT833-1, SOT1089, SOT996-2, SOT1116 and SOT1203	SOT902-2	
CP	1	7	clock input (LOW-to-HIGH, edge-triggered)
D	2	6	data input
Q	3	5	complement output
GND	4	4	ground (0 V)
Q	5	3	true output
RD	6	2	asynchronous reset-direct input (active LOW)
SD	7	1	asynchronous set-direct input (active LOW)
$V_{CC}$	8	8	supply voltage

## 7. Functional description

Table 4. Function table for asynchronous operation[1]

Input				Output	
SD	RD	СР	D	Q	Q
L	Н	X	X	Н	L
Н	L	X	X	L	Н
L	L	X	Χ	Н	Н

<sup>[1]</sup> H = HIGH voltage level;

Table 5. Function table for synchronous operation[1]

Input		Output			
SD	RD	СР	D	Q <sub>n+1</sub>	Q <sub>n+1</sub>
Н	Н	$\uparrow$	L	L	Н
Н	Н	<b>↑</b>	Н	Н	L

<sup>[1]</sup> H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

L = LOW voltage level;

 $<sup>\</sup>uparrow$  = LOW-to-HIGH CP transition;

 $Q_{n+1}$  = state after the next LOW-to-HIGH CP transition.

#### Single D-type flip-flop with set and reset; positive edge trigger

# 8. Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		-0.5	+6.5	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
$V_{I}$	input voltage		<u>[1]</u> –0.5	+6.5	V
I <sub>OK</sub>	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
$V_{O}$	output voltage	Active mode	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
		Power-down mode	<u>[1][2]</u> –0.5	+6.5	V
lo	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I <sub>CC</sub>	supply current		-	100	mA
$I_{GND}$	ground current		-100	-	mA
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40  ^{\circ}\text{C} \text{ to } +125  ^{\circ}\text{C}$	[3] _	300	mW
T <sub>stg</sub>	storage temperature		-65	+150	°C

<sup>[1]</sup> The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

# 9. Recommended operating conditions

Table 7. Operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
$V_{CC}$	supply voltage		1.65	5.5	V
VI	input voltage		0	5.5	V
$V_{O}$	output voltage	Active mode	0	$V_{CC}$	V
		Power-down mode; $V_{CC} = 0 V$	0	5.5	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.65 \text{ V to } 2.7 \text{ V}$	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 5.5 \text{ V}$	-	10	ns/V

<sup>[2]</sup> When  $V_{CC} = 0 \text{ V}$  (Power-down mode), the output voltage can be 5.5 V in normal operation.

<sup>[3]</sup> For TSSOP8 packages: above 55 °C the value of P<sub>tot</sub> derates linearly with 2.5 mW/K.
For VSSOP8 packages: above 110 °C the value of P<sub>tot</sub> derates linearly with 8.0 mW/K.
For XSON8 and XQFN8 packages: above 118 °C the value of P<sub>tot</sub> derates linearly with 7.8 mW/K.

#### Single D-type flip-flop with set and reset; positive edge trigger

### 10. Static characteristics

**Table 8.** Static characteristics
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T <sub>amb</sub> = -	40 °C to +85 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	$0.7 \times V_{CC}$	-	-	V
V <sub>IL</sub>	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	$0.3 \times V_{CC}$	V
V <sub>OH</sub>	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_O = -100 \mu A$ ; $V_{CC} = 1.65 V$ to 5.5 V	$V_{CC}-0.1$	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	1.54	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.9	2.15	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	2.50	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.3	2.62	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.8	4.11	-	V
V <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O}$ = 100 $\mu$ A; $V_{CC}$ = 1.65 V to 5.5 V	-	-	0.10	V
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	0.07	0.45	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	0.12	0.30	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	0.17	0.40	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	0.33	0.55	V
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	0.39	0.55	V
I <sub>I</sub>	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	±0.1	±5	μА
I <sub>OFF</sub>	power-off leakage current	$V_I$ or $V_O = 5.5$ V; $V_{CC} = 0$ V	-	±0.1	±10	μΑ
I <sub>CC</sub>	supply current	$V_I = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V; } I_O = 0 \text{ A}$	-	0.1	10	μΑ
Δl <sub>CC</sub>	additional supply current	per pin; $V_I = V_{CC} - 0.6 \text{ V}$ ; $I_O = 0 \text{ A}$ ; $V_{CC} = 2.3 \text{ V}$ to 5.5 V	-	5	500	μΑ
Cı	input capacitance		-	4.0	-	pF

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#### Single D-type flip-flop with set and reset; positive edge trigger

**Table 8. Static characteristics** ...continued
At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
T <sub>amb</sub> = -	40 °C to +125 °C					
V <sub>IH</sub>	HIGH-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	1.7	-	-	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	2.0	-	-	٧
		V <sub>CC</sub> = 4.5 V to 5.5 V	$0.7 \times V_{CC}$	-	-	V
<b>V</b> IL	LOW-level input voltage	V <sub>CC</sub> = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	V
		V <sub>CC</sub> = 2.3 V to 2.7 V	-	-	0.7	V
		V <sub>CC</sub> = 2.7 V to 3.6 V	-	-	0.8	V
		V <sub>CC</sub> = 4.5 V to 5.5 V	-	-	$0.3 \times V_{CC}$	V
Voн	HIGH-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O} = -100 \mu A$ ; $V_{CC} = 1.65 V$ to 5.5 V	V <sub>CC</sub> - 0.1	-	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	0.95	-	-	٧
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.7	-	-	٧
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	1.9	-	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.0	-	-	V
		$I_{O} = -32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.4	-	-	V
√ <sub>OL</sub>	LOW-level output voltage	$V_I = V_{IH}$ or $V_{IL}$				
		$I_{O}$ = 100 $\mu$ A; $V_{CC}$ = 1.65 V to 5.5 V	-	-	0.10	٧
		I <sub>O</sub> = 4 mA; V <sub>CC</sub> = 1.65 V	-	-	0.70	V
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.45	V
		$I_{O}$ = 12 mA; $V_{CC}$ = 2.7 V	-	-	0.60	V
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.80	٧
		$I_{O} = 32 \text{ mA}; V_{CC} = 4.5 \text{ V}$	-	-	0.80	٧
lı	input leakage current	V <sub>I</sub> = 5.5 V or GND; V <sub>CC</sub> = 0 V to 5.5 V	-	-	±20	μΑ
OFF	power-off leakage current	$V_I$ or $V_O = 5.5$ V; $V_{CC} = 0$ V	-	-	±20	μΑ
CC	supply current	$V_1 = 5.5 \text{ V or GND};$ $V_{CC} = 1.65 \text{ V to } 5.5 \text{ V; } I_O = 0 \text{ A}$	-	-	40	μΑ
7l <sup>CC</sup>	additional supply current	per pin; $V_I = V_{CC} - 0.6 \text{ V}$ ; $I_O = 0 \text{ A}$ ; $V_{CC} = 2.3 \text{ V}$ to 5.5 V	-	-	5000	μΑ

<sup>[1]</sup> All typical values are measured at  $T_{amb}$  = 25 °C.

#### Single D-type flip-flop with set and reset; positive edge trigger

# 11. Dynamic characteristics

Table 9. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); for test circuit see Figure 10.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	+125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	CP to Q, Q; see Figure 8	[2]				•		
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.0	13.4	1.5	13.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	7.1	1.0	7.1	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.5	7.1	1.0	7.1	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.5	5.9	1.0	5.9	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	2.5	4.1	1.0	4.1	ns
		SD to Q, Q; see Figure 9	[2]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.0	12.9	1.5	12.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.0	5.9	1.0	5.9	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	2.5	4.1	1.0	4.1	ns
		RD to Q, Q; see Figure 9	[2]						
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	5.0	12.9	1.5	12.9	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	3.5	7.0	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	3.0	5.9	1.0	5.9	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	2.5	4.1	1.0	4.1	ns
t <sub>W</sub>	pulse width	CP HIGH or LOW; see Figure 8							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		6.2	-	-	6.2	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.7	-	-	2.7	-	ns
		$V_{CC} = 2.7 \text{ V}$		2.7	-	-	2.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.7	1.3	-	2.7	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		2.0	-	-	2.0	-	ns
		SD and RD LOW; see Figure 9							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		6.2	-	-	6.2	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		2.7	-	-	2.7	-	ns
		$V_{CC} = 2.7 \text{ V}$		2.7	-	-	2.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		2.7	1.6	-	2.7	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		2.0	-	-	2.0	-	ns

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#### Single D-type flip-flop with set and reset; positive edge trigger

**Table 9. Dynamic characteristics** ...continued

Voltages are referenced to GND (ground = 0 V); for test circuit see <u>Figure 10</u>.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	–40 °C to +125 °C	
				Min	Typ[1]	Max	Min	Max	
t <sub>rec</sub>	recovery time	SD or RD; see Figure 9			'		1		
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.9	-	-	1.9	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.4	-	-	1.4	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.3	-	-	1.3	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		+1.2	-3.0	-	+1.2	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	-	-	1.0	-	ns
t <sub>su</sub>	set-up time	D to CP; see Figure 8							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		2.9	-	-	2.9	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.7	-	-	1.7	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.7	-	-	1.7	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.3	0.5	-	1.3	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.1	-	-	1.1	-	ns
t <sub>h</sub>	hold time	D to CP; see Figure 8							
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	-	-	1.5	-	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	-	-	1.0	-	ns
		$V_{CC} = 2.7 \text{ V}$		1.0	-	-	1.0	-	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	0.6	-	1.0	-	ns
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		1.0	-	-	1.0	-	ns
f <sub>max</sub>	maximum	CP; see Figure 8							
	frequency	$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		80	-	-	80	-	MHz
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		175	-	-	175	-	MHz
		$V_{CC} = 2.7 \text{ V}$		175	-	-	175	-	MHz
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		175	280	-	175	-	MHz
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$		200	-	-	200	-	MHz
C <sub>PD</sub>	power dissipation capacitance	$V_I = GND \text{ to } V_{CC};$ $V_{CC} = 3.3 \text{ V}$	[3]	-	15	-	-	-	pF

<sup>[1]</sup> Typical values are measured at  $T_{amb} = 25$  °C and  $V_{CC} = 1.8$  V, 2.5 V, 2.7 V, 3.3 V and 5.0 V respectively.

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o) \text{ where:}$ 

 $f_i$  = input frequency in MHz;

fo = output frequency in MHz;

 $C_L$  = output load capacitance in pF;

V<sub>CC</sub> = supply voltage in V;

N = number of inputs switching;

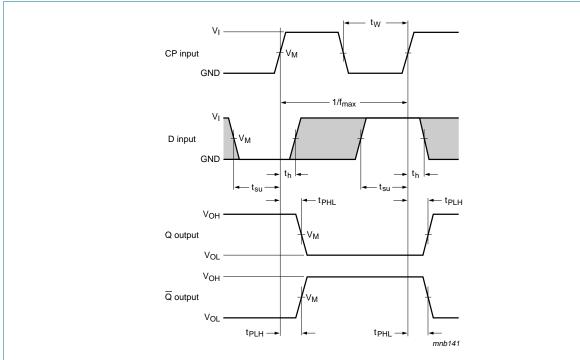
 $\Sigma(C_L \times V_{CC}^2 \times f_0)$  = sum of outputs.

<sup>[2]</sup> t<sub>pd</sub> is the same as t<sub>PLH</sub> and t<sub>PHL</sub>.

<sup>[3]</sup>  $C_{PD}$  is used to determine the dynamic power dissipation ( $P_D$  in  $\mu W$ ).

#### Single D-type flip-flop with set and reset; positive edge trigger

### 12. Waveforms



Measurement points are given in Table 10.

The shaded areas indicate when the input is permitted to change for predictable output performance.

 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig 8. The clock input (CP) to output (Q, Q) propagation delays, the clock pulse width, the D to CP set-up, the CP to D hold times and the maximum frequency

Table 10. Measurement points

Supply voltage	Input	Output
V <sub>CC</sub>	V <sub>M</sub>	V <sub>M</sub>
1.65 V to 1.95 V	$0.5 \times V_{CC}$	0.5 × V <sub>CC</sub>
2.3 V to 2.7 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$
2.7 V	1.5 V	1.5 V
3.0 V to 3.6 V	1.5 V	1.5 V
4.5 V to 5.5 V	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$

#### Single D-type flip-flop with set and reset; positive edge trigger

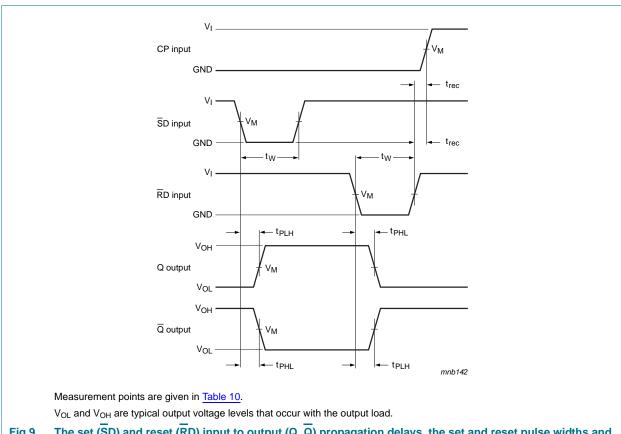
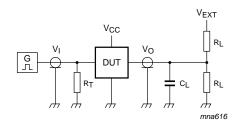


Fig 9. The set (SD) and reset (RD) input to output (Q, Q) propagation delays, the set and reset pulse widths and the RD to CP recovery time

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#### Single D-type flip-flop with set and reset; positive edge trigger



Test data is given in Table 11.

Definitions for test circuit:

R<sub>L</sub> = Load resistance.

 $C_L$  = Load capacitance including jig and probe capacitance.

 $R_T$  = Termination resistance should be equal to the output impedance  $Z_0$  of the pulse generator.

 $V_{EXT}$  = External voltage for measuring switching times.

Fig 10. Test circuit for measuring switching times

Table 11. Test data

Supply voltage Input			Load	Load		V <sub>EXT</sub>		
V <sub>CC</sub>	Vı	t <sub>r</sub> , t <sub>f</sub>	CL	$R_L$	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	$t_{PZL}, t_{PLZ}$	
1.65 V to 1.95 V	V <sub>CC</sub>	$\leq$ 2.0 ns	30 pF	1 k $\Omega$	open	GND	$2V_{CC}$	
2.3 V to 2.7 V	V <sub>CC</sub>	≤ 2.0 ns	30 pF	$500 \Omega$	open	GND	$2V_{CC}$	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	$500 \Omega$	open	GND	6 V	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	GND	6 V	
4.5 V to 5.5 V	V <sub>CC</sub>	≤ 2.5 ns	50 pF	500 Ω	open	GND	2V <sub>CC</sub>	

Single D-type flip-flop with set and reset; positive edge trigger

# 13. Package outline

TSSOP8: plastic thin shrink small outline package; 8 leads; body width 3 mm; lead length 0.5 mm SOT505-2

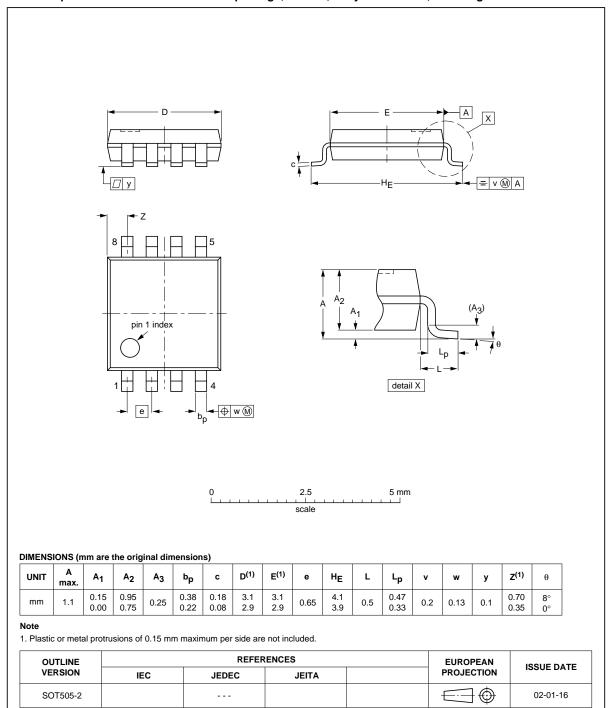


Fig 11. Package outline SOT505-2 (TSSOP8)

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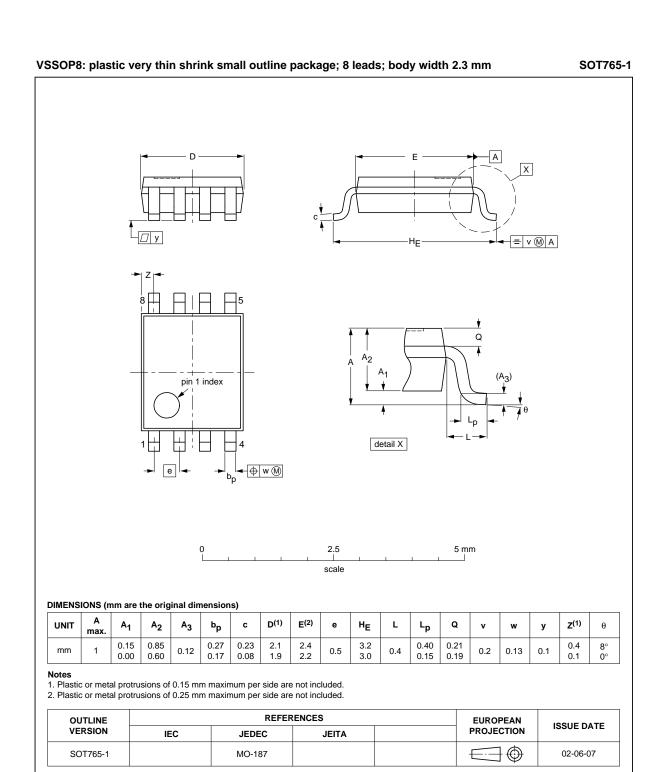


Fig 12. Package outline SOT765-1 (VSSOP8)

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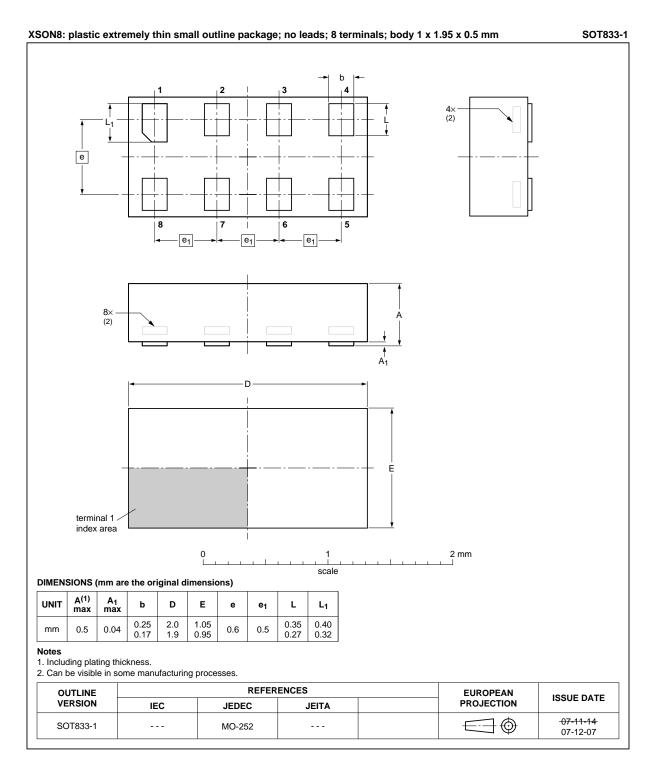


Fig 13. Package outline SOT833-1 (XSON8)

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Single D-type flip-flop with set and reset; positive edge trigger

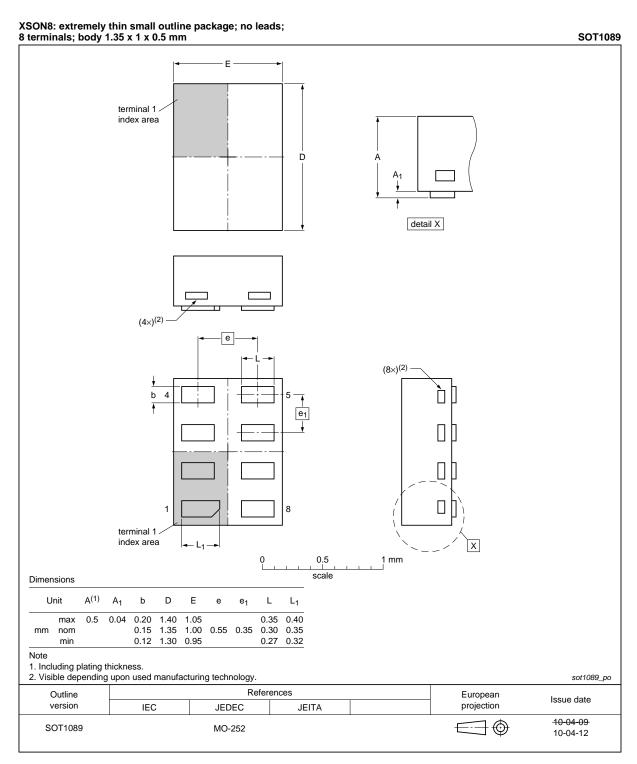


Fig 14. Package outline SOT1089 (XSON8)

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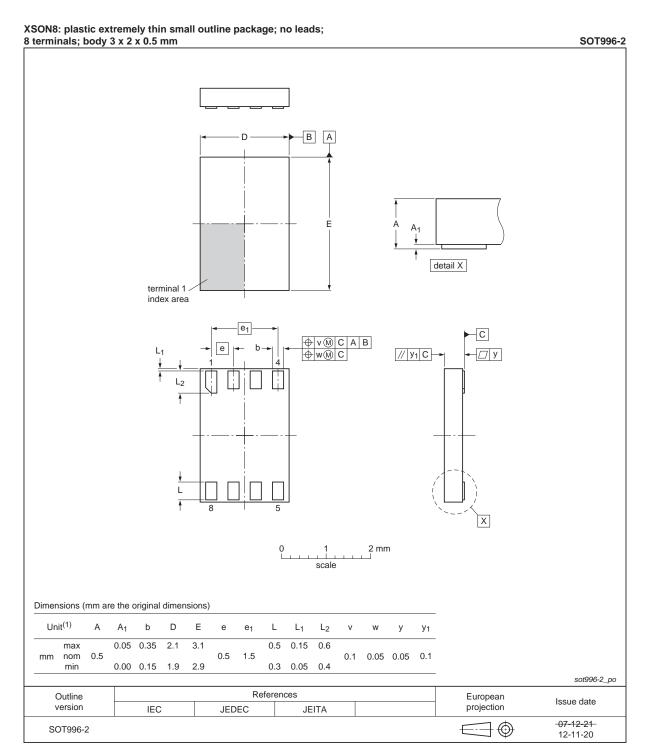


Fig 15. Package outline SOT996-2 (XSON8)

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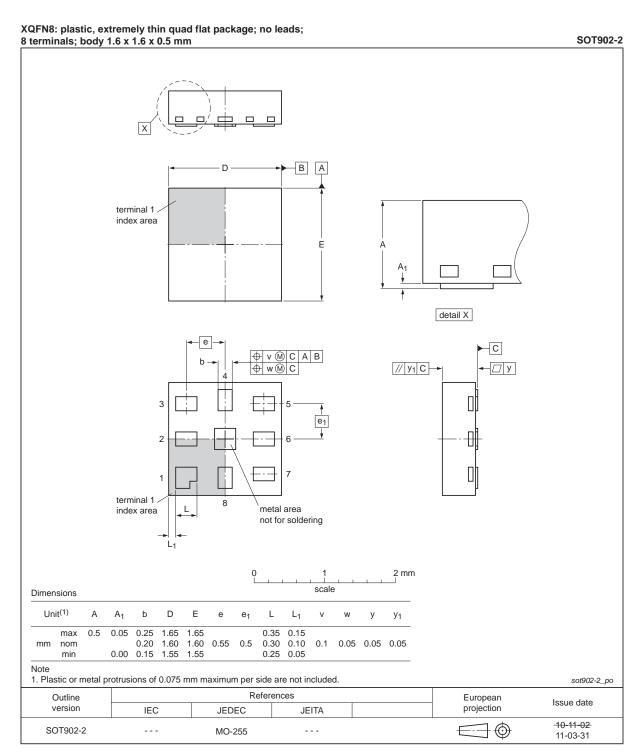


Fig 16. Package outline SOT902-2 (XQFN8)

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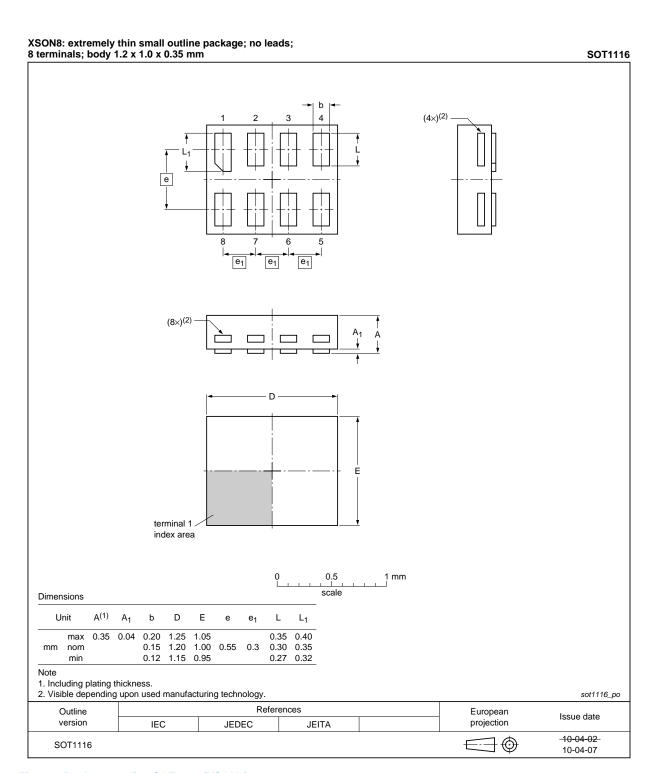


Fig 17. Package outline SOT1116 (XSON8)

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Single D-type flip-flop with set and reset; positive edge trigger

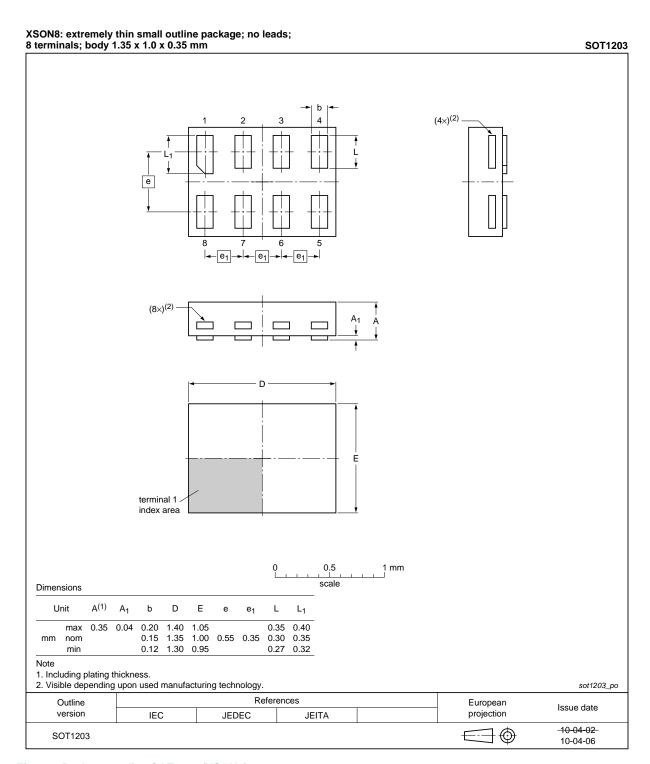


Fig 18. Package outline SOT1203 (XSON8)

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#### Single D-type flip-flop with set and reset; positive edge trigger

### 14. Abbreviations

#### Table 12. Abbreviations

Acronym	Description
CMOS	Complementary Metal-Oxide Semiconductor
HBM	Human Body Model
ESD	ElectroStatic Discharge
MM	Machine Model
DUT	Device Under Test
TTL	Transistor-Transistor Logic

## 15. Revision history

#### Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVC1G74 v.12	20130402	Product data sheet	-	74LVC1G74 v.11
Modifications:	<ul> <li>For type num</li> </ul>	ber 74LVC1G74GD XSON8U	has changed to XS0	ON8.
74LVC1G74 v.11	20120604	Product data sheet	-	74LVC1G74 v.10
Modifications:	<ul> <li>For type num</li> </ul>	ber 74LVC1G74GM the SOT	code has changed to	SOT902-2.
74LVC1G74 v.10	20111202	Product data sheet	-	74LVC1G74 v.9
Modifications:	<ul> <li>Legal pages</li> </ul>	updated.		
74LVC1G74 v.9	20100805	Product data sheet	-	74LVC1G74 v.8
74LVC1G74 v.8	20091203	Product data sheet	-	74LVC1G74 v.7
74LVC1G74 v.7	20080626	Product data sheet	-	74LVC1G74 v.6
74LVC1G74 v.6	20080219	Product data sheet	-	74LVC1G74 v.5
74LVC1G74 v.5	20070809	Product data sheet	-	74LVC1G74 v.4
74LVC1G74 v.4	20061207	Product data sheet	-	74LVC1G74 v.3
74LVC1G74 v.3	20050201	Product specification	-	74LVC1G74 v.2
74LVC1G74 v.2	20040909	Product specification	-	74LVC1G74 v.1
74LVC1G74 v.1	20040202	Product specification	-	-

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#### 16.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
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#### Single D-type flip-flop with set and reset; positive edge trigger

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